

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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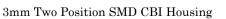
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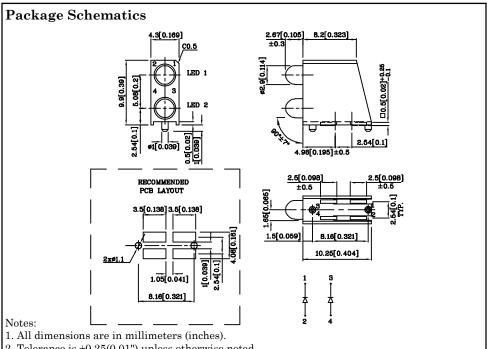


Features

- Black casing provides superior contrast
- Reliable & robust
- Custom color combinations available
- \bullet MSL (Moisture Sensitivity Level): 3
- Housing material: PPA
- Housing UL rating: 94V-0
- High temperature resistant housing
- \bullet High glass transition temperature epoxy
- RoHS compliant







- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Green (GaP)	Unit
Reverse Voltage	V_{R}	5	V
Forward Current	I_{F}	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA
Power Dissipation	PD	62.5	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

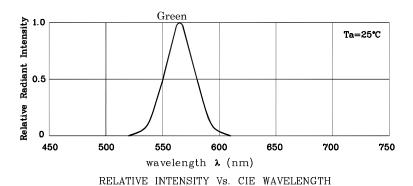
Operating Characteristics (T _A =25°C)		Green (GaP)	Unit
Forward Voltage (Typ.) (I _F =10mA)	V_{F}	2	V
Forward Voltage (Max.) (I _F =10mA)	V_{F}	2.5	V
Reverse Current (Max.) $(V_R=5V)$	I_R	10	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (IF=10mA)	λР	565*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) (IF=10mA)	λD	568*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	Δλ	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	pF

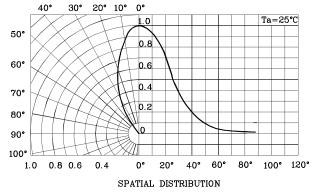
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (IF=10mA)mcd		Wavelength CIE127-2007* λ P nm	Viewing Angle 20 1/2
				min.	typ.		
XRS2LUG11D	Green	GaP	Green Diffused	10*	24*	565*	50°

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

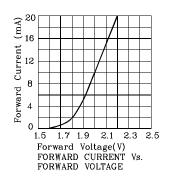


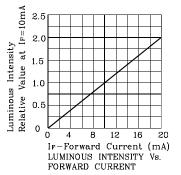


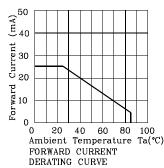


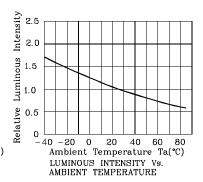


❖ Green



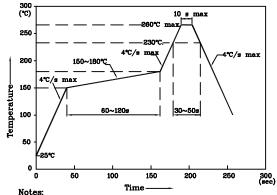






LED is recommended for reflow soldering and soldering profile is shown below.

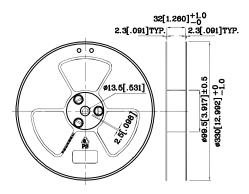
Reflow Soldering Profile for SMD Products (Pb-Free Components)



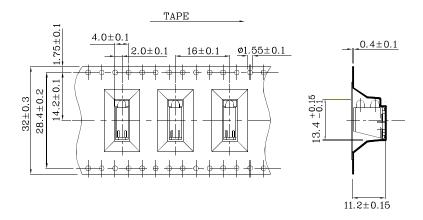
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions



* Reel Dimension



* Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: \pm -0.1V

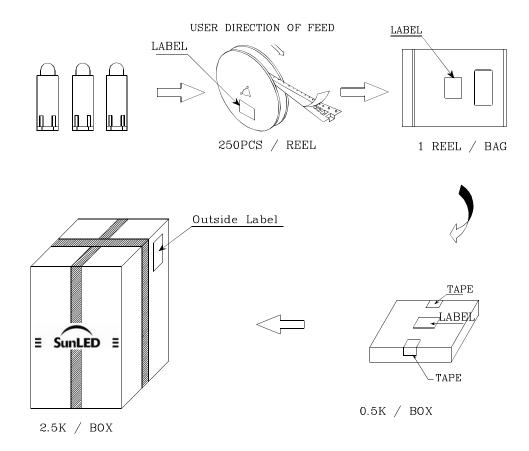
Note: Accuracy may depend on the sorting parameters.

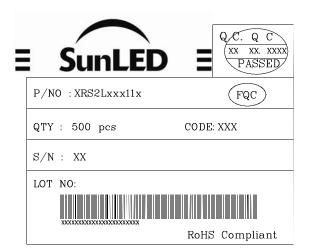
Oct 10,2016

XDSA9438 V6-Z Layout: Maggie L.



PACKING & LABEL SPECIFICATIONS





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- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

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